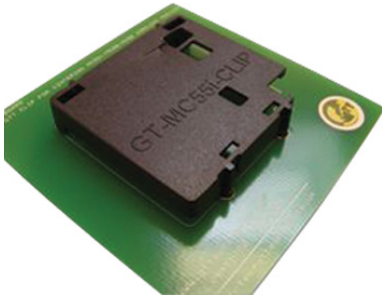


PCB Mounting Clip MC55i



Feature:

- PCB mounting clip design for Cinterion wireless module

Specifications:

Board to Board Connector Information:

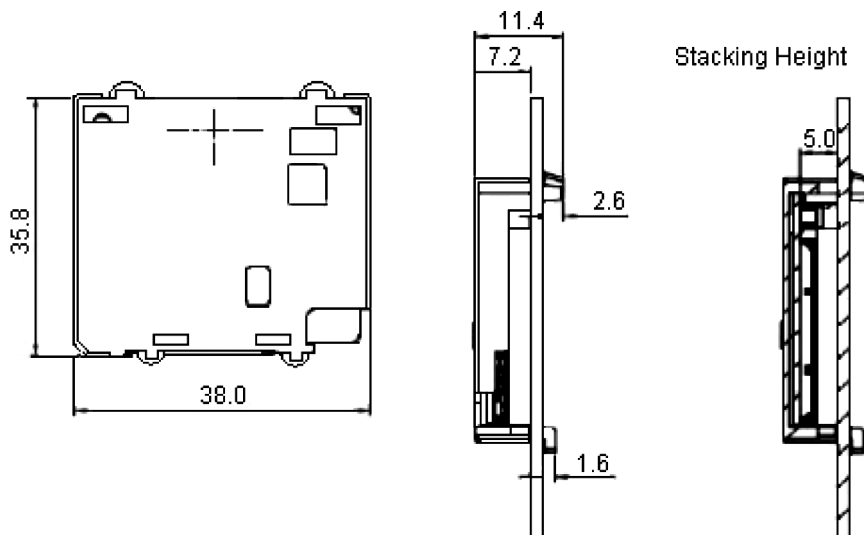
Size	: 50 pins
Stacking Height	: 5mm
PCB Mating Board Thickness	: 1.6mm
Pulling Force (module clip on PCB)	: Minimum 10N Maximum 150N

Clip Specifications:

Physical:

Clip Material	: PC-940A
Clip Colour	: Black
Operating Temperature	: -40°C to +100°C

Assembled Dimensions:

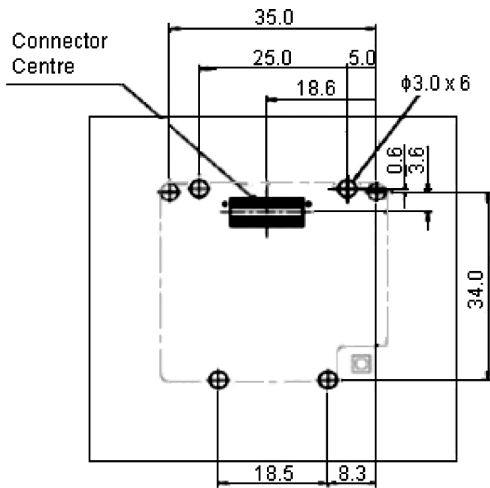


Dimensions : Millimetres

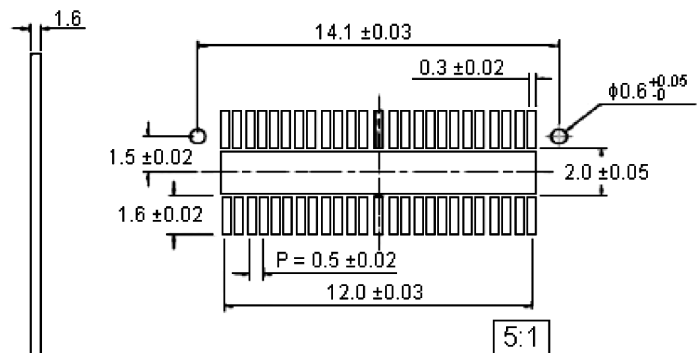
PCB Mounting Clip MC55i



Module Clip PCB Footprint and Connector Receptacle Dimensions:



Module Clip PCB Footprint

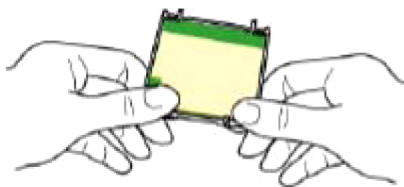
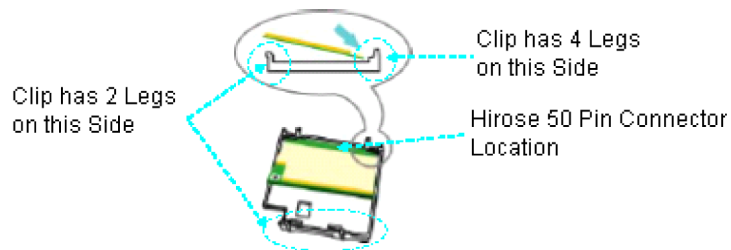


PCB Connector Receptacle Dimensions

Dimensions : Millimetres

Mounting Clip for Cinterion:

Mounting Instructions (Module into Clip):



1st Step:

Orientate the module in the clip: the side with a 50 pin connector is the side which goes into the clip first.

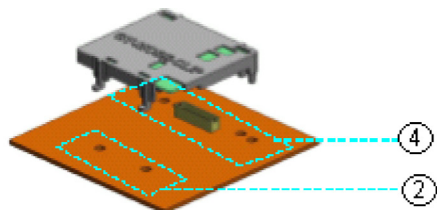
Insert the module at an inclined angle, sliding the edge of the PCB underneath the two retaining lugs of the clip.

2nd Step:

Press the other side of the module vertically downwards to fit it into the clip.

PCB Mounting Clip

MC55i

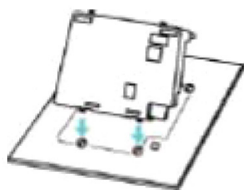


1st Step:

Orientate the clip legs with the PCB mounting holes with 'GT-MC55i-CLIP' characters upright.

④ 4 holes at the top, near the receptacle.

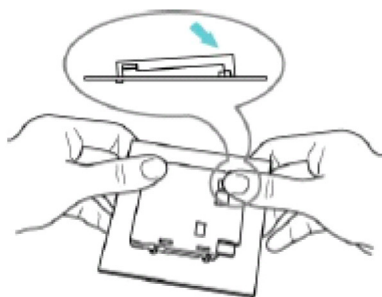
② 2 holes at the bottom.



2nd Step:

Insert the 2 legs of the clip first, into the corresponding holes on the PCB footprint.

Be sure to completely insert the 2 legs before beginning the 3rd step.



3rd Step:

While inserting the other 4 legs, the 50 pin connector will, at the same time, match into the receptacle on the PCB.

Please be sure the direction of the force exerted on the clip/module is at a 45° angle downwards (as suggested by the arrow in the schematic) and not vertically at 90°.

Part Number Table

Description	Part Number
Clip, PCB, MC55i	GT-MC55i-CLIP-F

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